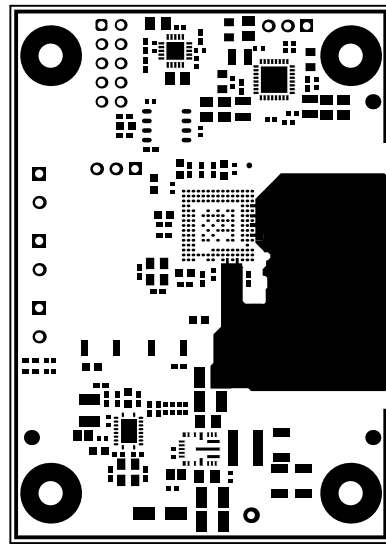
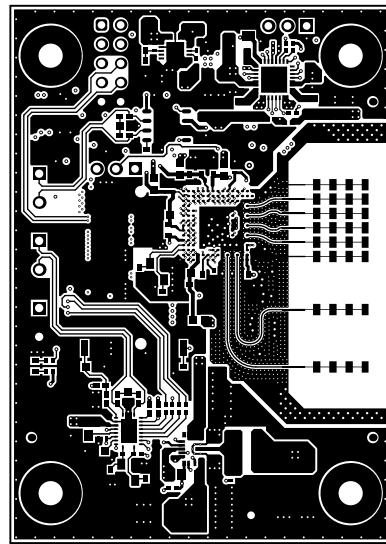


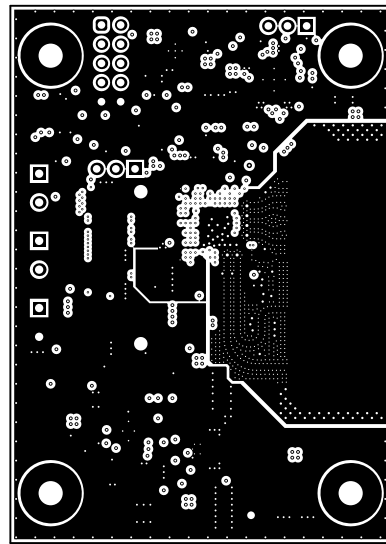
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 11/8/2017 11:44:16 AM	TEXAS INSTRUMENTS	



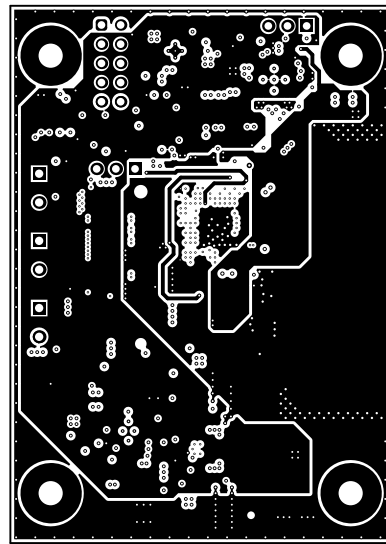
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 11/8/2017 11:44:17 AM	TEXAS INSTRUMENTS	



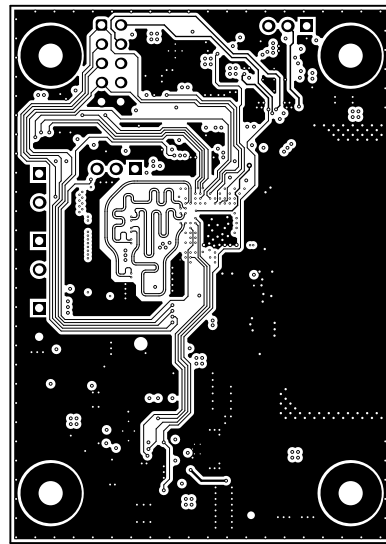
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 1 - Top Layer			
PLOT NAME = Top Layer	GENERATED : 11/8/2017 11:44:18 AM	TEXAS INSTRUMENTS	



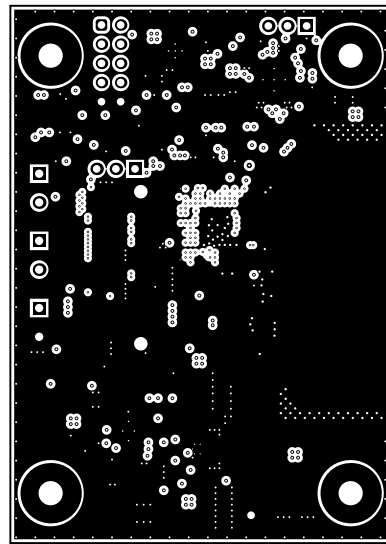
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 2 - GND			
PLOT NAME = Signal Layer 1	GENERATED : 11/8/2017 11:44:18 AM	TEXAS INSTRUMENTS	



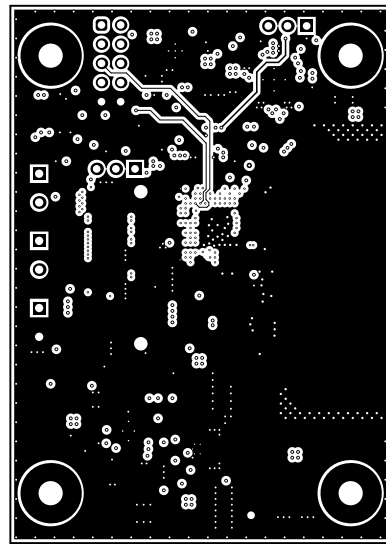
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 7 - PWR / Signal			
PLOT NAME = Signal Layer 2	GENERATED : 11/8/2017 11:44:19 AM	TEXAS INSTRUMENTS	



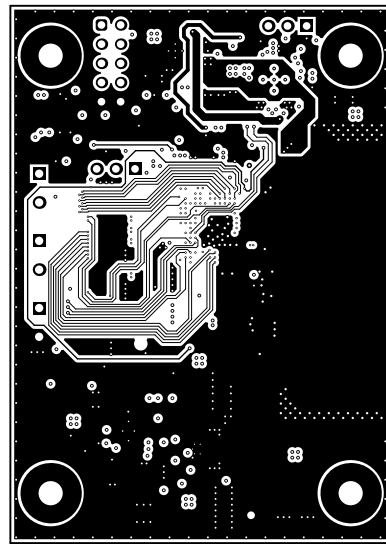
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 3 - Signal (Sensitive)			
PLOT NAME = Signal Layer 3	GENERATED : 11/8/2017 11:44:20 AM	TEXAS INSTRUMENTS	



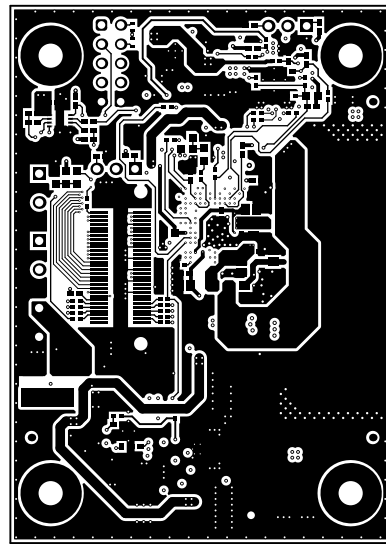
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 6 - GND			
PLOT NAME = Signal Layer 4	GENERATED : 11/8/2017 11:44:21 AM	TEXAS INSTRUMENTS	



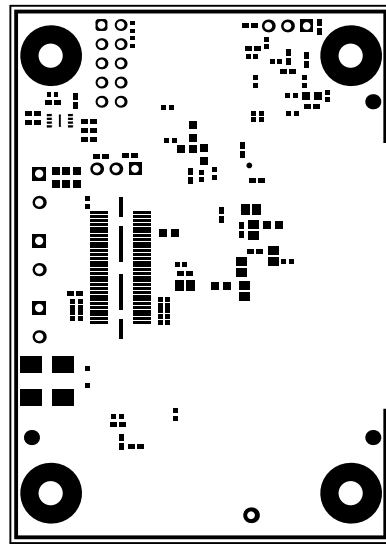
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 4 - GND / Signal			
PLOT NAME = Signal Layer 5	GENERATED : 11/8/2017 11:44:21 AM	TEXAS INSTRUMENTS	



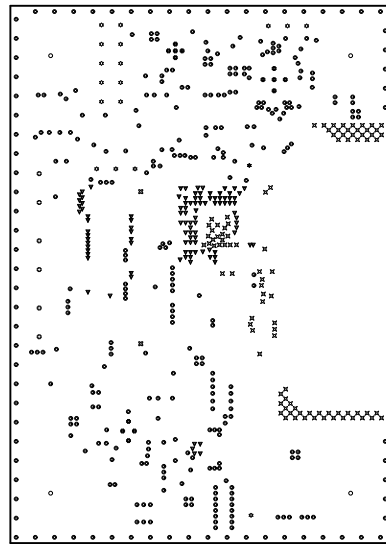
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 5 - Signal			
PLOT NAME = Signal Layer 6	GENERATED : 11/8/2017 11:44:22 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 8 - Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 11/8/2017 11:44:23 AM	TEXAS INSTRUMENTS	

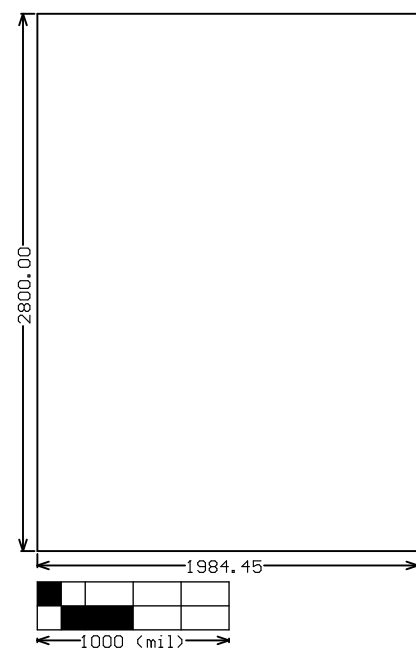


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 11/8/2017 11:44:23 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
⊗	2	40.16mil (1.020mm)	NPTH	Round	Layer 1 - Top Layer - Layer 8 - Bottom Layer	
∇	106	6.00mil (0.152mm)	PTH	Round	Layer 1 - Top Layer - Layer 8 - Bottom Layer	
⊕	14	7.87mil (0.200mm)	PTH	Round	Layer 1 - Top Layer - Layer 8 - Bottom Layer	
⊙	355	10.00mil (0.254mm)	PTH	Round	Layer 1 - Top Layer - Layer 8 - Bottom Layer	
⊛	1	12.00mil (0.305mm)	PTH	Round	Layer 1 - Top Layer - Layer 8 - Bottom Layer	
⊗	93	12.20mil (0.310mm)	PTH	Round	Layer 1 - Top Layer - Layer 8 - Bottom Layer	
⊛	17	40.00mil (1.016mm)	PTH	Round	Layer 1 - Top Layer - Layer 8 - Bottom Layer	
⊕	6	43.31mil (1.100mm)	PTH	Round	Layer 1 - Top Layer - Layer 8 - Bottom Layer	
○	4	125.98mil (3.200mm)	PTH	Round	Layer 1 - Top Layer - Layer 8 - Bottom Layer	
	598 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 11/8/2017 11:44:25 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01570	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 11/8/2017 11:44:26 AM	TEXAS INSTRUMENTS	

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